

# INTERNATIONAL STANDARD

# IEC 60297-3-103

First edition  
2004-08

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## **Mechanical structures for electronic equipment – Dimensions of mechanical structures of the 482,6 mm (19 in) series –**

### **Part 3-103: Keying and alignment pin**



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### Part 3-103: Keying and alignment pin

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**MECHANICAL STRUCTURES FOR ELECTRONIC EQUIPMENT –  
DIMENSIONS OF MECHANICAL STRUCTURES  
OF THE 482,6 mm (19 in) SERIES –**

**Part 3-103: Keying and alignment pin**

**FOREWORD**

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International Standard IEC 60297-3-103 has been prepared by subcommittee 48D: Mechanical structures for electronic equipment, of IEC technical committee 48: Electro-mechanical components and mechanical structures for electronic equipment.

This standard cancels and replaces IEC 60297-5-104 and 60297-5-105.

The text of this standard is based on following documents:

FDIS	Report on voting
48D/301/FDIS	48D/308/RVD

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

The IEC 60297-3 series consists of the following parts, under the general title *Mechanical structures for electronic equipment – Dimensions of mechanical structures of the 482,6 mm (19 in) series*

Part 3-101: Subracks and associated plug-in units

Part 3-102: Injector/extractor handle

Part 3-103: Keying and alignment pin

The committee has decided that the contents of this publication will remain unchanged until the maintenance result date indicated on the IEC web site under "<http://webstore.iec.ch>" in the data related to the specific publication. At this date, the publication will be

- reconfirmed;
- withdrawn;
- replaced by a revised edition, or
- amended.

A bilingual edition of this standard may be issued at a later date.